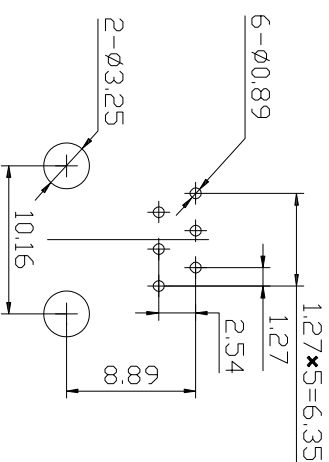
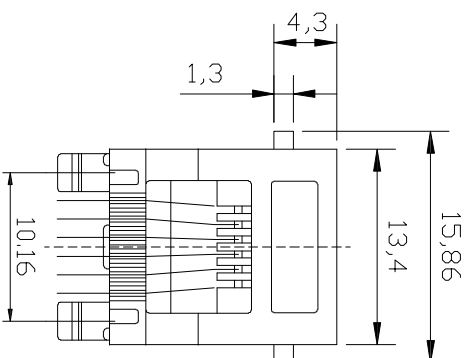
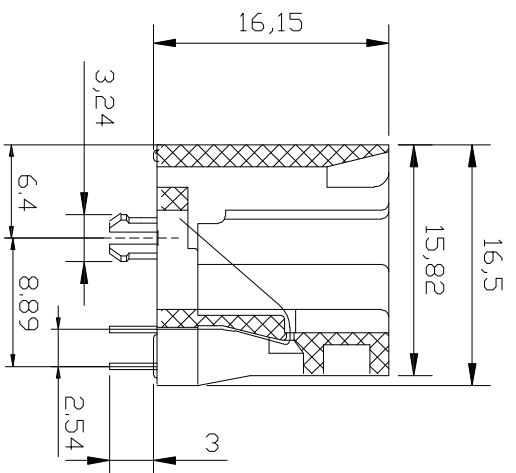




PC Board Layout
Component Side Shown

NOTES:
MATERIAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $\phi=0.46\text{mm}$.
3. PLATING : GOLD PLATING OVER NICKEL.

ELECTRICAL:

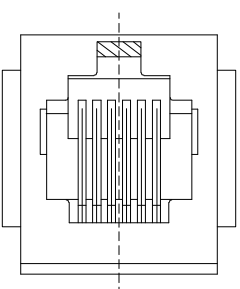
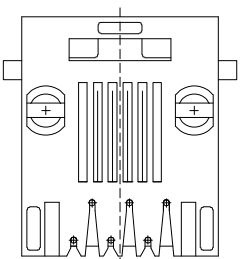
1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : -25° C TO 85° C.



TOLERANCE TABLE

.0	±0.30
.00	±0.20
.000	±0.05

APPROVED:	DATE:	C km tw 深圳市灿科盟实业有限公司 CHANKEMENG INDUSTRYCO., LTD			
CHECKED:	DATE:				
DRAWN:	DATE:	R J11S06P-A005 深圳市灿科盟实业有限公司 CHANKEMENG INDUSTRYCO., LTD			
HCY	2014-05-26				
UNIT	mm	SCALE	free	REV.	A
FILE NO.	Ckmtw-RJ11-0084	REV.	A	HY04	